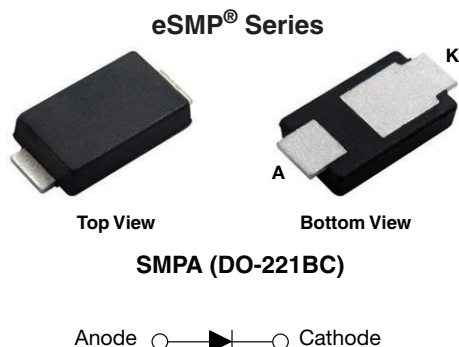


## Surface-Mount ESD Capability Rectifiers



### FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Not recommended for PCB bottom side wave mounting
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2.0 A
$V_{RRM}$	100 V, 200 V, 400 V, 600 V
$I_{FSM}$	32 A
$V_F$ at $I_F = 2.0$ A ( $T_A = 125$ °C)	0.92 V
$I_R$	5 $\mu$ A
$T_J$ max.	175 °C
Package	SMPA (DO-221BC)
Circuit configuration	Single

### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

### MECHANICAL DATA

**Case:** SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes the cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SE20PAB	SE20PAD	SE20PAG	SE20PAJ	UNIT
Device marking code		20B	20D	20G	20J	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	100	200	400	600	V
Maximum DC forward current	I <sub>F</sub> <sup>(1)</sup>	2.0				A
	I <sub>F</sub> <sup>(2)</sup>	1.4				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	32				A
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175				°C

### Notes

(1) Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 1.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.93	-	V
	I <sub>F</sub> = 2.0 A			1.00	1.10	
	I <sub>F</sub> = 1.0 A	T <sub>A</sub> = 125 °C		0.83	-	
	I <sub>F</sub> = 2.0 A			0.92	1.00	
Reverse current	Rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	5	μA
		T <sub>A</sub> = 125 °C		7	100	
Typical reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A		t <sub>rr</sub>	1.3	-	μs
Typical junction capacitance	4.0 V, 1 MHz		C <sub>J</sub>	13	-	pF

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: Pulse width  $\leq 40\text{ ms}$ **THERMAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

PARAMETER	SYMBOL	SE20PAB	SE20PAD	SE20PAG	SE20PAJ	UNIT
Typical thermal resistance	R <sub>θJA</sub> <sup>(1)</sup>	120				°C/W
	R <sub>θJM</sub> <sup>(2)</sup>	9				

**Notes**(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient(2) Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB;  $R_{\theta JM}$  - junction to mount**IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS**( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}$ , $R = 1.5\text{ k}\Omega$	$V_C$	H3B	$> 8\text{ kV}$

**ORDERING INFORMATION** (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE20PAJ-M3/I	0.033	I	14 000	13" diameter plastic tape and reel
SE20PAJHM3/I <sup>(1)</sup>	0.033	I	14 000	13" diameter plastic tape and reel

**Note**

(1) AEC-Q101 qualified



## RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

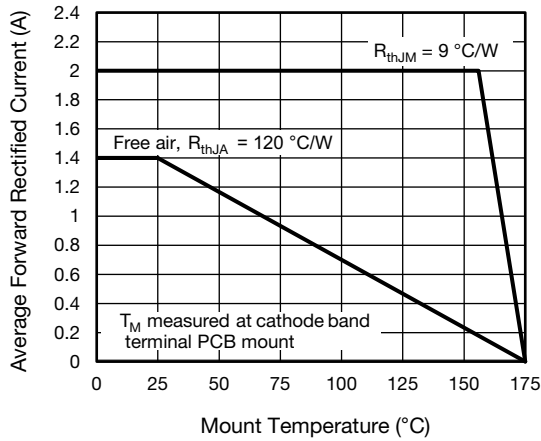


Fig. 1 - Maximum Forward Current Derating Curve

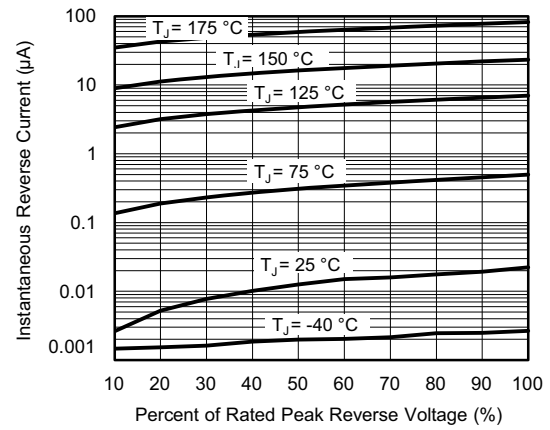


Fig. 4 - Typical Reverse Leakage Characteristics

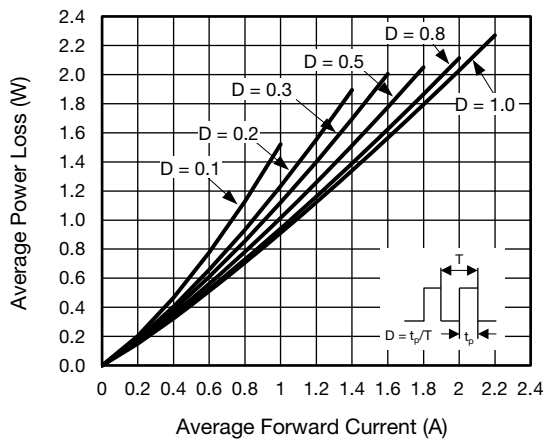


Fig. 2 - Forward Power Loss Characteristics

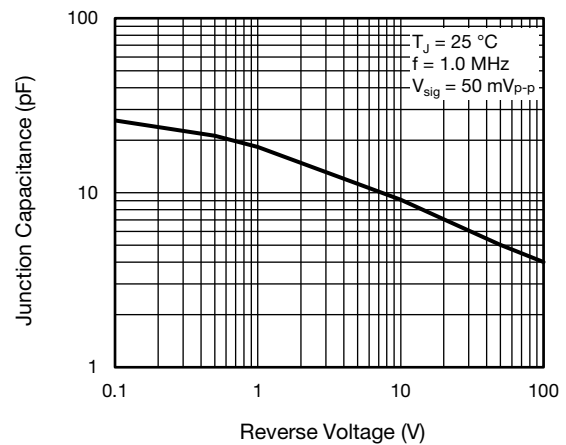


Fig. 5 - Typical Junction Capacitance

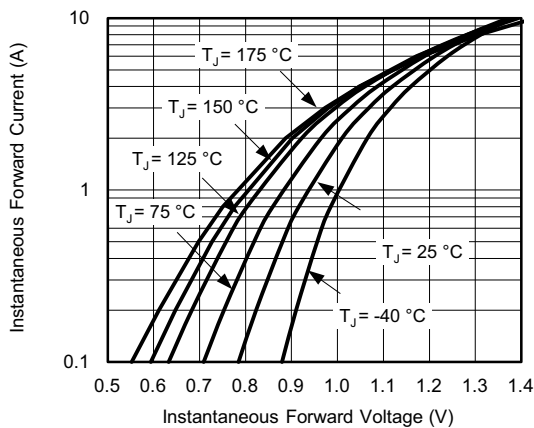


Fig. 3 - Typical Instantaneous Forward Characteristics

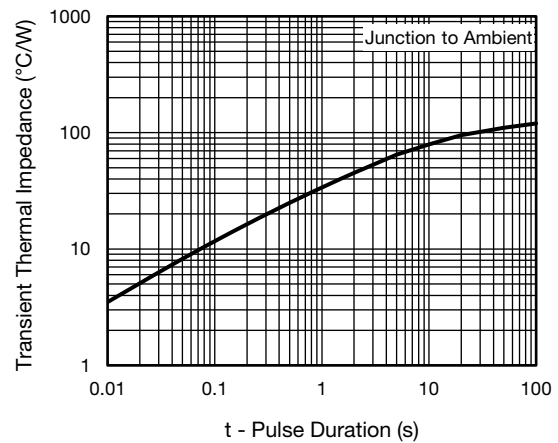
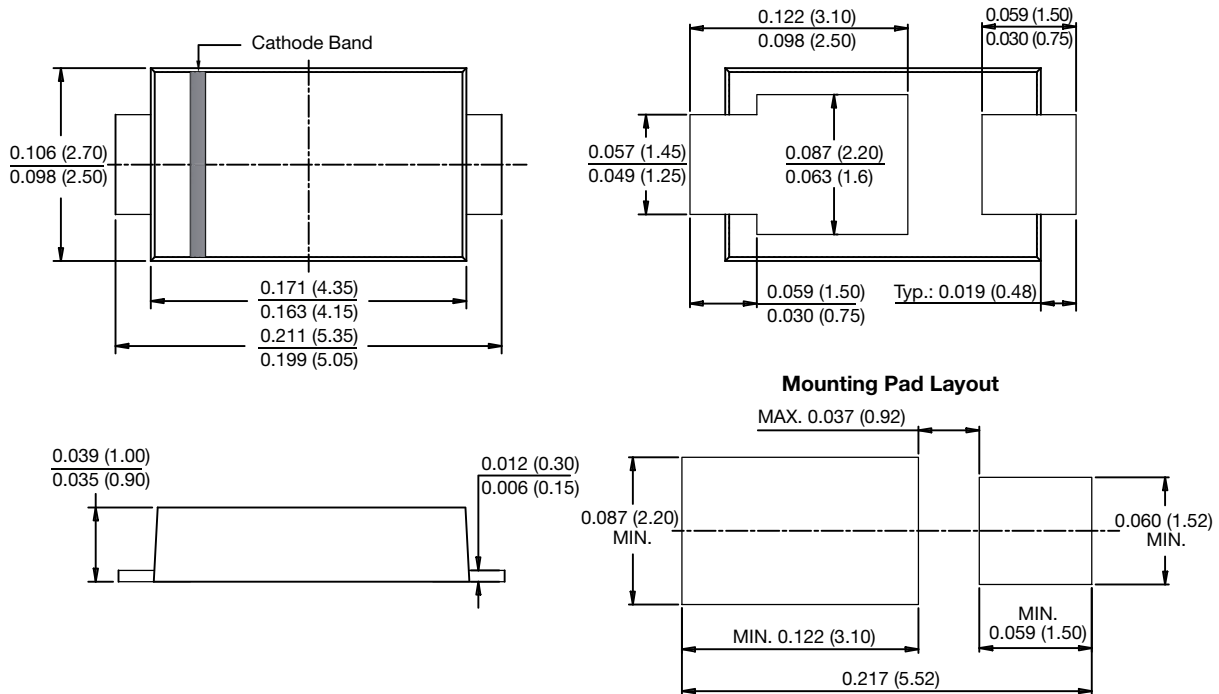


Fig. 6 - Typical Transient Thermal Impedance



## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### SMPS (DO-221BC)





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